

1206 Slow Blow SMD Fuses

DOC.No. ISS:F12T1.25

INDIVIDUAL SPECIFICATION SHEET

Product Name: 1206 Slow Blow SMD Fuses

Part Number: :F12T1.25

Revision: B



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Rev.	Effective Date	Changed Contents
Α	2020-10-27	New Release
В	2021-3-10	Update Spedfications

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PREPEARED BY	APPROVED BY
杨绮	AMBA



Description

F12T Series are the fuses set the industry standard for performance, reliability and quality. The solder-free design provides excellent on-off and temperature cycling characteristics during use and also makes our SMD fuses more heat and shock tolerant than typical subminiature fuses.



Electrical Characteristics					
Rated Current	1.0In	2.5In	3.0In	3.5ln	10.0ln
1.25A	4 hour min.	5 sec max.	0.1sec – 3sec	-	0.2ms – 20ms

Features

- High inrush current withstanding capability
- > AEC-Q200 Automotive Grade Certified
- Compatible with reflow and wave solder
- > Ceramic and glass construction
- Excellent environmental integrity
- One time positive disconnect
- Lead Free and Halogen free material

Specifications

Specification							
	Rated	Rated Current	Breaking Capacity (A) ¹	Typical Cold. Resistance (mOhms) ²	Typical Voltage Drop (mV)	Typical Pre- Arcing I ² t (A ² Sec) ³	Alpha Mark
Part No.	Voltage	(A)					
	DC						
F12T1.25	72V	1.25	50A	330	500	0.15	Н

- 1. DC Interrupting Rating (Measured at rated voltage, time constant of less than 50 microseconds, battery source)
- 2. DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25°C
- 3. Typical Pre-arcing I²t are measured at 10In Current

 Choice fuse for surge application (USB charger etc.), make sure the I²t of fuse is 4 times than surge.

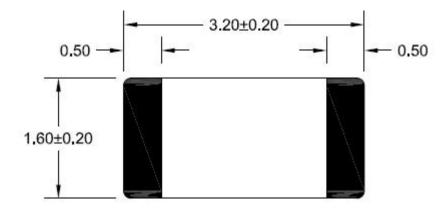
 Specifications are subject to change without notice. Application testing is strongly recommended.



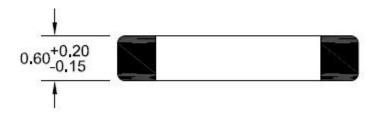
Dimension

Drawing not to scale (Unit: mm)

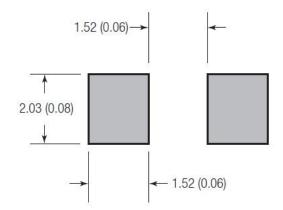
Top view



Side view

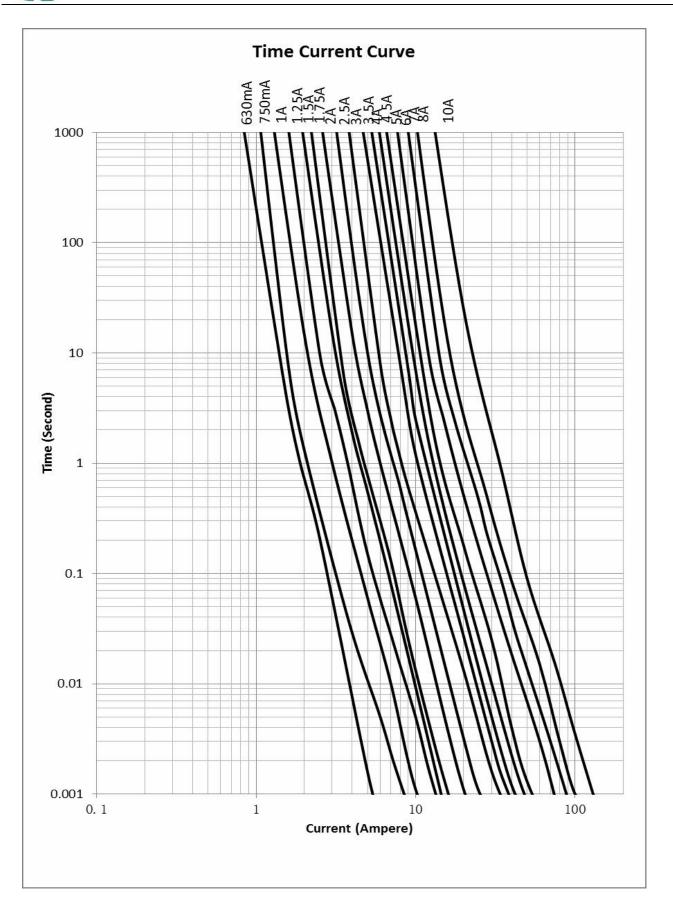


Recommended land pattern



Unit: mm(inch)







Idering method

Wave solder

■ Reservoir temperature: 260°C

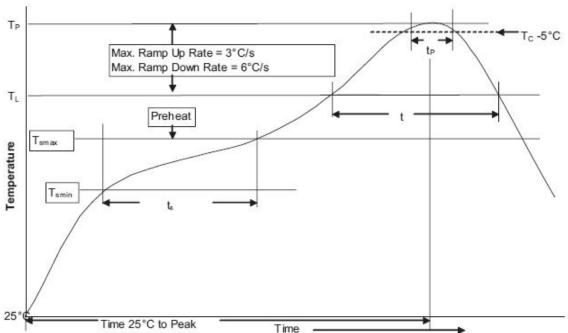
■ Time in reservoir: 10 seconds maximum

Infrared reflow

■ Temperature: 260°C

■ Time: 30 seconds maximum

Solder reflow profile



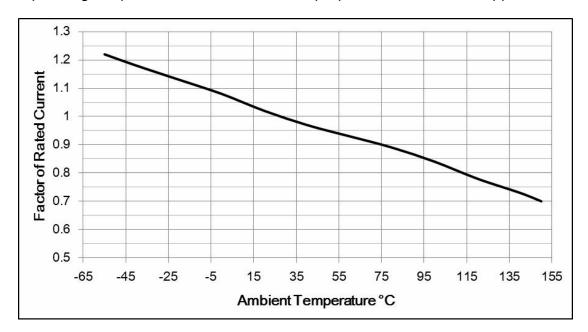
I III E				
Profile Feature	Lead(Pb) free solder			
Preheat and soak	Temperature min.(T _{smin})	150°C		
	Temperature max. (T _{smax})	200°C		
	• Time (T _{smin} to T _{smax}) (t _S)	60 - 120 Seconds		
Average ramp up rate T _{smax} to T	3°C / Second Max.			
Liquidous temperature (T _L)	217°C			
Time at liquidous (t _L)	60 - 150 Seconds			
Peak package body temperature	260°C			
Time (t _P) within 5°C of the specif	30 Seconds			
Average ramp-down rate (TP to	6°C / Second Max.			
Time (25°C to Peak Temperatur	8 Minutes Max.			



Temperature Derating Curve

Normal ambient temperature: 23+/-3°C

Operating temperature: -55 ~ 125°C, with proper correction factor applied



Package

3000 fuses on 8mm tape-and-reel on a 7 inch (178mm) reel per EIA Standard 481.

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